



DOCKET: FIS9-2003-0227-US1

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR: Todd H. Buley)
SERIAL NO.: 10/605,257)
FILING DATE: September 18, 2003) DATE: October 11, 2005
FOR: INCLINED SOLDER WAVE METHODOLOGY FOR WAVE
SOLDERING DOUBLE SIDED PIN-IN-HOLE ELECTRONIC
COMPONENTS

CHANGE OF CORRESPONDENCE ADDRESS FOR ALL PURPOSES

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 CFR §1.33, please change the correspondence address, (Customer No. 32074), for all purposes for the above identified patent application and resulting patent to:

**INTERNATIONAL BUSINESS MACHINES CORPORATION
Intellectual Property Law/Zip 482
2070 Route 52
Hopewell Junction, New York 12533-6531**

Respectfully submitted,

Peter W. Peterson
Reg. No. 31,867

ibmf100398000ChgCorrAdd